

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6755186

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the PREVIOUS RECORDATION WHICH DOES NOT INCLUDE 2ND AND 3RD INVENTORS previously recorded on Reel 056404 Frame 0899. Assignor(s) hereby confirms the ASSIGNMENT OF ASSIGNORS INTEREST.

CONVEYING PARTY DATA

Name	Execution Date
SEUNGHYUN SONG	06/01/2021
KANG-ILL SEO	06/09/2021

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17335834

CORRESPONDENCE DATA

Fax Number: (202)293-7860

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-293-7060

Email: yleggitt@sughrue.com, sughrue@sughrue.com

Correspondent Name: SUGHRUE MION, PLLC

Address Line 1: 2000 PENNSYLVANIA AVENUE, N.W.

Address Line 2: SUITE 900

Address Line 4: WASHINGTON, D.C. 20006

ATTORNEY DOCKET NUMBER:	A262563
NAME OF SUBMITTER:	YUKIKO LEGGITT - TEAMS DEPT
SIGNATURE:	/Yukiko Leggitt/
DATE SIGNED:	06/10/2021
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 16

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source=A262563RCNORasfiled#page5.tif
source=A262563RCNORasfiled#page6.tif
source=A262563RCNORasfiled#page7.tif
source=A262563RCNORasfiled#page8.tif
source=A262563RCNORasfiled#page9.tif
source=A262563RCNORasfiled#page10.tif
source=A262563RCNORasfiled#page11.tif
source=A262563AssignmentandDeclarationexecutedbyByounggakHong1stInventor#page1.tif
source=A262563AssignmentandDeclarationexecutedbyByounggakHong1stInventor#page2.tif
source=A262563AssignmentandDeclarationexecutedbyByounggakHong1stInventor#page3.tif
source=A262563AssignmentandDeclarationexecutedbyByounggakHong1stInventor#page4.tif
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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BYOUNGHAK HONG	05/27/2021
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17335834
CORRESPONDENCE DATA	
Fax Number:	(202)293-7860
Phone:	202-293-7060
Email:	msmircich@sughrue.com, sughrue@sughrue.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	SUGHRUE MION, PLLC.
Address Line 1:	2000 PENNSYLVANIA AVENUE, N.W.
Address Line 2:	9TH FLOOR
Address Line 4:	WASHINGTON, D.C. 20006
ATTORNEY DOCKET NUMBER:	A262563
NAME OF SUBMITTER:	MATTHEW TYLER SMIRCICH-TEAMS
Signature:	/Matthew Tyler Smircich/
Date:	06/01/2021
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 5	

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RECEIPT INFORMATION

EPAS ID: PAT6739104
Receipt Date: 06/01/2021

**COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY PATENT APPLICATION AND
ASSIGNMENT FORM¹**

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

Title: **DIFFERENT DIFFUSION BREAK STRUCTURES FOR THREE-DIMENSIONAL STACKED SEMICONDUCTOR DEVICE**

for which Assignor is about to make or has made United States or International application for patent.

WHEREAS, as a below named inventor(s), I/(we) hereby declare that:

Section I. Declaration

This declaration is directed to:

- The attached U.S. non-provisional patent application, or
- U.S. non-provisional patent application number 17/335,834, filed on June 1, 2021, or
- PCT international patent application number _____, filed on _____.

The above-identified application was made or authorized to be made by me (us).

I (we) believe that I am (we are) the original inventor (original joint inventors) of a claimed invention in the above-identified application.

I (we) hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

¹ This form requires the use of an Application Data Sheet.

SEC Ref No. WB-202102-010-1 Attorney Ref No. A262563

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge that I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part,

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divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.

The undersigned hereby grant(s) the law firm of **Sughrue Mion, PLLC** the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

SEC Ref No. WB-202102-010-1 Attorney Ref No. A262563

COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM

Page 3 of 4

PATENT
REEL: 056540 FRAME: 0424

Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Hong	Byounggak	
SIGNATURE _____ DATE _____			

LEGAL NAME OF SECOND INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Song	Seunghyun	
SIGNATURE <u>/seunghyun song/</u> DATE <u>2021/06/01</u>			

LEGAL NAME OF THIRD INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Seo	Kang-ill	
SIGNATURE _____ DATE _____			

SEC Ref No. WB-202102-010-1 Attorney Ref No. A262563

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SEMICONDUCTOR DEVICE**

for which Assignor is about to make or has made United States or International application for patent.

WHEREAS, as a below named inventor(s), I/(we) hereby declare that:

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This declaration is directed to:

- The attached U.S. non-provisional patent application, or
- U.S. non-provisional patent application number _____, filed on _____, or
- PCT international patent application number _____, filed on _____.

The above-identified application was made or authorized to be made by me (us).

I (we) believe that I am (we are) the original inventor (original joint inventors) of a claimed invention in the above-identified application.

I (we) hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

¹ This form requires the use of an Application Data Sheet.

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SAMSUNG ELECTRONICS CO., LTD.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge that I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign

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Attorney Ref No.

A262563

SAMSUNG ELECTRONICS CO., LTD.

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LEGAL NAME OF FIRST INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Hong	Byounggak	
<p>SIGNATURE _____ /Byounggak Hong/ DATE 05.27.2021</p>			

LEGAL NAME OF SECOND INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Song	Seunghyun	
<p>SIGNATURE _____ DATE _____</p>			

LEGAL NAME OF THIRD INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Seo	Kang-ill	
<p>SIGNATURE _____ /Kang-ill Seo/ DATE 06.09.2021</p>			

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WB-202102-010-1

Attorney Ref No. _____

A262563

SAMSUNG ELECTRONICS CO., LTD.

countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

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Attorney Ref No. _____

A262563

Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Hong	Byounggak	
<p>SIGNATURE _____ /Byounggak Hong/ DATE 05.27.2021</p>			

LEGAL NAME OF SECOND INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Song	Seunghyun	
<p>SIGNATURE _____ DATE _____</p>			

LEGAL NAME OF THIRD INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Seo	Kang-ill	
<p>SIGNATURE _____ DATE _____</p>			

SEC Ref **WB-202102-010-1** Attorney Ref No. **A262563**
 No. _____

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